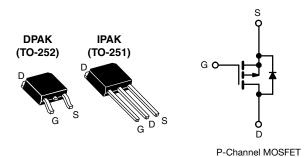


Vishay Siliconix

Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	-100			
R _{DS(on)} (Ω)	$V_{GS} = -10 \text{ V}$	0.60		
Q _g (Max.) (nC)	18			
Q _{gs} (nC)	3.0			
Q _{gd} (nC)	9.0			
Configuration	Sin	igle		

FEATURES

- · Dynamic dV/dt rating
- · Repetitive avalanche rated
- Surface-mount (IRFR9120, SiHFR9120)
- Straight lead (IRFU9120, SiHFU9120)
- Available in tape and reel
- P-channel
- Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface-mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lead (Pb)-free and	SiHFR9120-GE3	SiHFR9120TR-GE3 a	SiHFR9120TRL-GE3 a	-	SiHFU9120-GE3	
halogen-free	IRFR9120PbF-BE3	IRFR9120TRPbF-BE3	IRFR9120TRLPbF-BE3	-	-	
Lead (Pb)-free	IRFR9120PbF	IRFR9120TRPbF a	IRFR9120TRLPbF a	IRFR9120TRRPbF	IRFU9120PbF	

Note

a. See device orientation

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	-100	V
Gate-source voltage			V_{GS}	± 20	v
Continuous drain current	V et 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I-	-5.6	
Continuous drain current	VGS at -10 V	T _C = 100 °C	l _D	-5.6	А
Pulsed drain current ^a			I _{DM}	-22	
Linear derating factor				0.33	W/°C
Linear derating factor (PCB mount) e				0.020	
Single pulse avalanche energy ^b			E _{AS}	210	mJ
Repetitive avalanche current a			I _{AR}	-5.6	Α
Repetitive avalanche energy a			E _{AR}	4.2	mJ
Maximum power dissipation	T _C =	25 °C		42	W
Maximum power dissipation (PCB mount) e T _A = 25 °C			P_D	2.5	VV
Peak diode recovery dV/dt ^c			dV/dt	-5.5	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) ^d	For	10 s		260	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. $V_{DD} = -25 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 10 \,^{\circ}\text{mH}$, $R_g = 25 \,^{\circ}\Omega$, $I_{AS} = -5.6 \,^{\circ}\text{A}$ (see fig. 12)
- c. $I_{SD} \le$ 6.8 A, $dI/dt \le$ 110 A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le$ 150 °C
- d. 1.6 mm from case
- e. When mounted on 1" square PCB (FR-4 or G-10 material)

IRFR9120, IRFU9120, SiHFR9120, SiHFU9120

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	-	110	
Maximum junction-to-ambient (PCB mount) ^a	R _{thJA}	-	-	50	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	-	3.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA		- 100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.098	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-source leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zoro goto veltogo droin overent	1	V _{DS} =	-100 V, V _{GS} = 0 V	-	-	- 100	
Zero gate voltage drain current	I _{DSS}	V _{DS} = -80 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	- 500	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = - 3.4 A ^b	-	-	0.60	Ω
Forward transconductance	9 _{fs}	V _{DS} =	- 50 V, I _D = - 3.4 A	1.5	-	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	390	-	
Output capacitance	C _{oss}		V _{DS} = - 25 V,	-	170	1	рF
Reverse transfer capacitance	C _{rss}	f = 1	f = 1.0 MHz, see fig. 5		45	1	1
Total gate charge	Qg			-	-	18	
Gate-source charge	Q _{gs}	$V_{GS} = -10 \text{ V}$ $I_D = -6.8 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 ^b		-	-	3.0	nC
Gate-drain charge	Q _{gd}	1	See fig. 6 and 16	-	-	9.0	
Turn-on delay time	t _{d(on)}			-	9.6	1	
Rise time	t _r	V_{DD} = - 50 V, I_{D} = - 6.8 A, R_{g} = 18 Ω , R_{D} = 7.1 Ω , see fig. 10 ^b		-	29	-	- ns
Turn-off delay time	t _{d(off)}			-	21	-	
Fall time	t _f			-	25	-	
Internal drain inductance	L _D	Between 6 mm (0.25	") from	-	4.5	-	-11
Internal source inductance	L _S	package and die cont	٠	-	7.5	-	nH
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	MOSFET sym showing the	bol	-	-	- 5.6	_
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	- 22	A
Body diode voltage	V _{SD}	T _J = 25 °C,	$I_S = -5.6 \text{ A}, V_{GS} = 0 \text{ V}^b$	-	-	- 6.3	V
Body diode reverse recovery time	t _{rr}	T 05 °C 1	6.0 V 41/4+ 100 V/·-p	-	100	200	ns
Body diode reverse recovery charge	Q _{rr}	$J = 25 \text{G}, I_{\text{F}}$	= - 6.8 A, dl/dt = 100 A/μs ^b	-	0.33	0.66	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width $\leq 300~\mu s;~duty~cycle \leq 2~\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

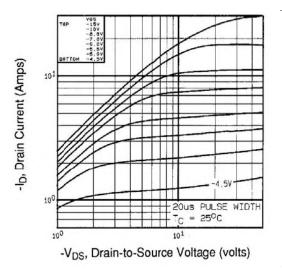


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

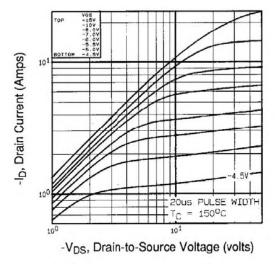
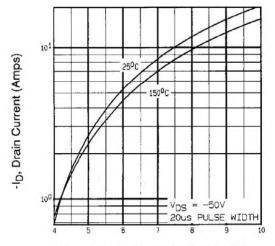


Fig. 1 - Typical Output Characteristics, $T_C = 150$ °C



-VGS, Gate-to-Source Voltage (volts)

Fig. 2 - Typical Transfer Characteristics

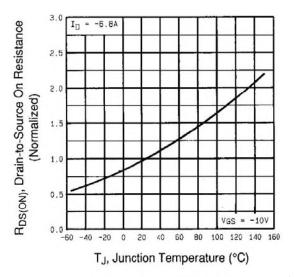


Fig. 3 - Normalized On-Resistance vs. Temperature

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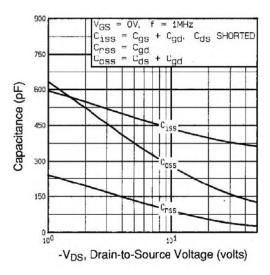


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

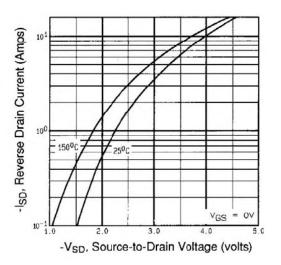


Fig. 6 - Typical Source-Drain Diode Forward Voltage

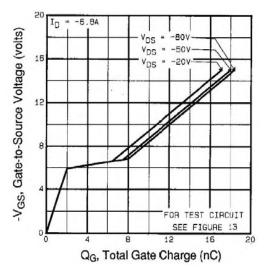


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

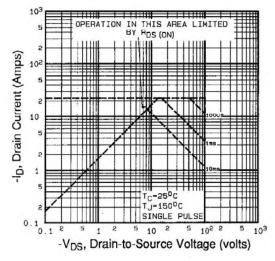


Fig. 7 - Maximum Safe Operating Area

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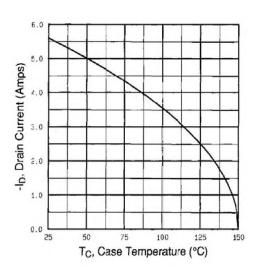


Fig. 8 - Maximum Drain Current vs. Case Temperature

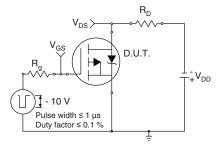


Fig. 10a - Switching Time Test Circuit

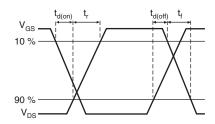


Fig. 10b - Switching Time Waveforms

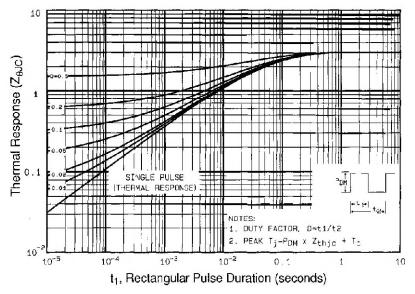


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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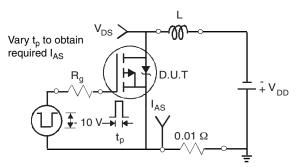


Fig. 12a - Unclamped Inductive Test Circuit

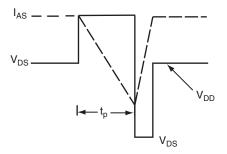


Fig. 12b - Unclamped Inductive Waveforms

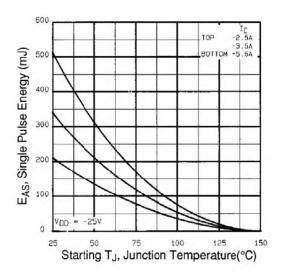


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

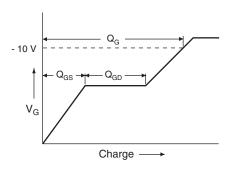


Fig. 13a - Basic Gate Charge Waveform

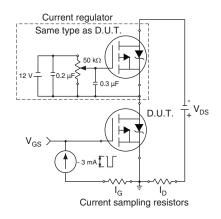
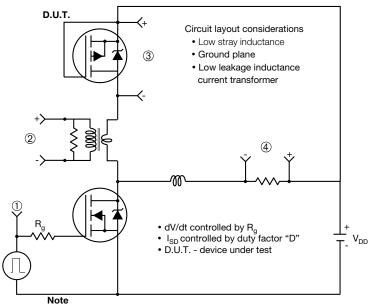


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

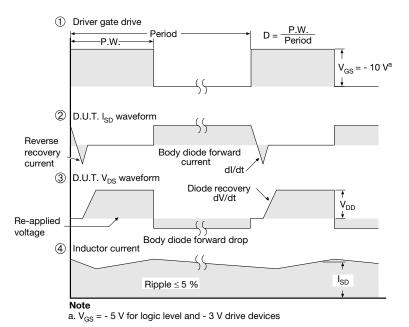


Fig. 10 - For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91280.

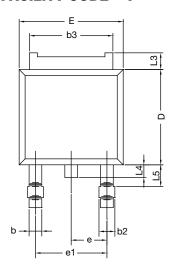
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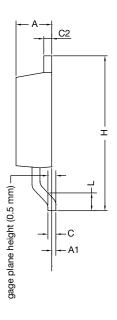


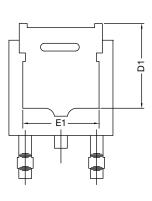
TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y

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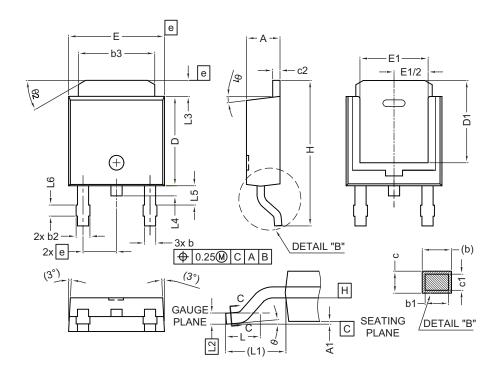
	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56	BSC	
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	=	
Е	6.35	6.73	
E1	4.32	=	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

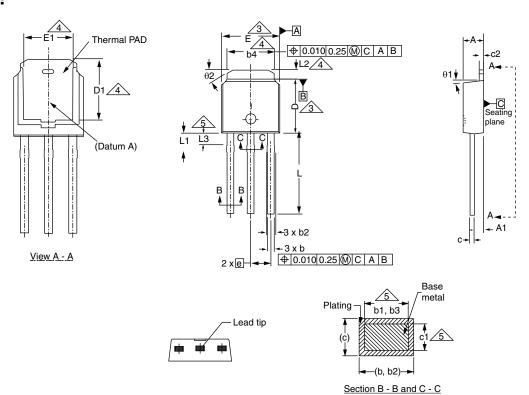
ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347

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Case Outline for TO-251AA (High Voltage)

OPTION 1:



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	=	0.170	=
е	2.29	2.29 BSC		BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'
	•		•	

ECN: E21-0682-Rev. C, 27-Dec-2021

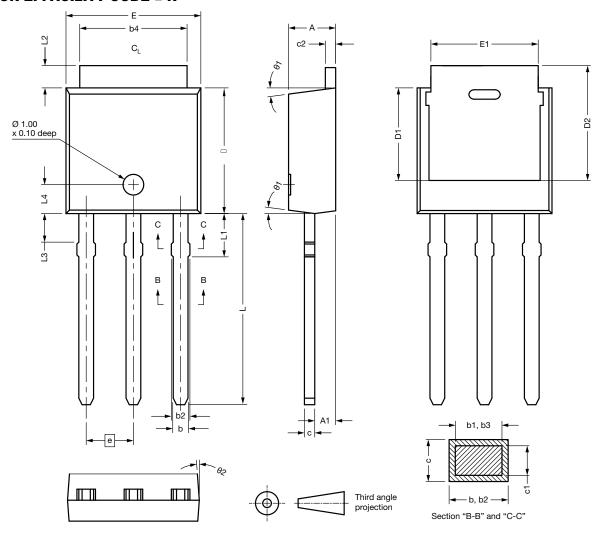
DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA



OPTION 2: FACILITY CODE = N



DIM.	MIN.	NOM.	MAX.
Α	2.180	2.285	2.390
A1	0.890	1.015	1.140
b	0.640	0.765	0.890
b1	0.640	0.715	0.790
b2	0.760	0.950	1.140
b3	0.760	0.900	1.040
b4	4.950	5.205	5.460
С	0.460	-	0.610
c1	0.410	-	0.560
c2	0.460	-	0.610
D	5.970	6.095	6.220
D1	4.300	-	-

DIM.	MIN.	NOM.	MAX.
D2	5.380	-	-
E	6.350	6.540	6.730
E1	4.32	-	-
е	2.29	BSC	
L	8.890	9.270	9.650
L1	1.910	2.100	2.290
L2	0.890	1.080	1.270
L3	1.140	1.330	1.520
L4	1.300	1.400	1.500
θ1	0°	7.5°	15°
θ2	4°	-	-

ECN: E21-0682-Rev. C, 27-Dec-2021

DWG: 5968

- Dimensioning and tolerancing per ASME Y14.5M-1994
- All dimension are in millimeters, angles are in degrees
- Heat sink side flash is max. 0.8 mm



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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